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Espinoza et al.

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(54)	CLAY-FREE READY-MIXED SETTING-TYPE JOINT COMPOUND				
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(56)		References Cited			
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(57) ABSTRACT

A two part joint compound which sets by hydration of calcium sulfate hemihydrate to gypsum and is clay-free. One part includes an in-situ acidic acrylate copolymer thickener (i.e., an associative thickener) with the calcium sulfate hemihydrate, along with a non-calcium bearing phosphate set preventer. The first part contains water, but remains unset for at least 175 days. The second part includes a set initiator compound having a cation with a log K value greater than calcium ions. The second part is mixed with the first part when setting is desired.

27 Claims, No Drawings